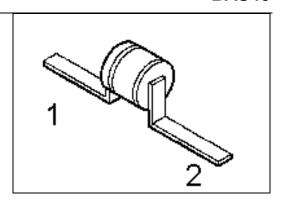


# HiRel Silicon Schottky Diode

- HiRel Discrete and Microwave Semiconductor
- General-purpose diodes for high-speed switching
- Circuit protection
- Voltage clamping
- High-level detecting and mixing
- Hermetically sealed microwave package
- **@esa** Space Qualified

ESA/SCC Detail Spec. No.: 5512/020

Type Variant No. 03



**ESD**: Electrostatic discharge sensitive device, observe handling precautions!

Туре	Marking	Ordering Code	Pin Configuration	Package
BAS40-T1 (ql)	-	see below	1 — 2	T1

(ql) Quality Level: P: Professional Quality

H: High Rel Quality

S: Space Quality

ES: ESA Space Quality

(see order instructions for ordering example)



Max	kimum	Ratings

Parameter	Symbol	Values	Unit
Reverse Voltage	V <sub>R</sub>	40	V
Forward Current	I <sub>F</sub>	120	mA
Surge Forward Current 1)	I <sub>FSM</sub>	170	mA
Power Dissipation 2)	P <sub>tot</sub>	250	mW
Operating Temperature Range	T <sub>op</sub>	-55 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Soldering Temperature 3)	T <sub>sol</sub>	+250	°C
Junction Temperature	Tj	150	°C
Thermal Resistance Junction-Case	R <sub>th(j-c)</sub>	100	K/W

### **Electrical Characteristics**

at T<sub>A</sub>=25°C; unless otherwise specified

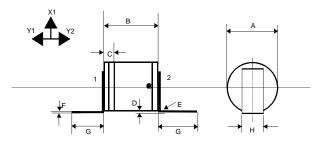
Parameter	Symbol		Values		Unit
		min.	typ.	max.	
DC Characteristics					
Reverse Current 1, V <sub>R</sub> =40V	I <sub>R1</sub>	-	-	10	μΑ
Reverse Current 2, V <sub>R</sub> =30V	I <sub>R2</sub>	-	-	1	μΑ
Forward Voltage 1, I <sub>F1</sub> =1mA	V <sub>F1</sub>	0,29	0,33	0,39	V
Forward Voltage 2, I <sub>F2</sub> =10mA	$V_{F2}$	0,42	0,45	0,54	V
Forward Voltage 3, I <sub>F3</sub> =40mA	$V_{F3}$	0,68	0,7	0,85	V
Differential Forward Resistance 4)	R <sub>FD</sub>	7,5	10	11,5	Ω
IF=10mA, IF=15mA					
AC Characteristics					
Total Capacitance	Ст	2,2	2,9	5,0	pF
$V_R=0V$ ; $f=1MHz$					

## Notes.:

- 1.)  $t \le 10$ ms, Duty Cycle=10% 2.) At  $T_{CASE} = 125$  °C. For  $T_{CASE} > 125$  °C derating is required. 3.) During 5 sec. maximum. The same terminal shall not be resoldered until 3 minutes have elapsed.



### T1 Package



Symbol	Millimetre		
	min	max	
Α	1,30	1,45	
В	1,15	1,35	
С	-	0,40	
D	0,10	0,50	
E	-	0,30	
F	0,06	0,10	
G	5,50	-	
Н	0,40	0,60	

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